

WATERTOWN DIVISION

PRELIMINARY

UPGA301A

Nanosecond SCR SWITCH

PRODUCT PREVIEW

DESCRIPTION

Designed for high current narrow-pulse switching applications where size and current handling capability are critical. These devices may be triggered on using low power logic drivers from (+0.8 V at 200 µA).

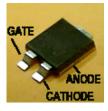
Epoxy packaged, oxide passivated planar SCR chips with metallurgic bonds on both sides to achieve high reliability. Internal wire bond connection allows high current surge capability for narrow pulse applications.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

| ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED) | | | | | |
|---|------------------|------------|------|--|--|
| Rating | Symbol | Value | Unit | | |
| Repetative peak Off-State Voltage | V _{DRM} | 125 | V | | |
| Peak On-State Current | I _{TSM} | 100 | А | | |
| Peak Gate Current | I _{GM} | 250 | mA | | |
| Reverse Gate Voltage | V_{GR} | 5 | V | | |
| Storage Temperature Range | Τs | -50 to 150 | °C | | |
| Operating Temperature Range | ΤJ | -25 to 125 | °C | | |

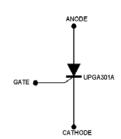
| THERMAL CHARACTERISTICS (UNLESS OTHERWISE SPECIFIED) | | | | |
|---|----|-----|---------|--|
| Thermal Resistance | | | | |
| Junction-to Case (Anode) | RJ | 4.0 | °C/Watt | |

(1) Mounted on 2" square by 0.06' thick FR4 board with a 1" x 1" square 2 ounce copper pattern.
(2) Mounted on 0.06 thick FR4 board, using recommended footprint.



Small foot print

Foot print Area 16.51 mm² 1:1 Actual size (anode contact)



KEY FEATURES

- Powermite 3 [®] Package
- Small Mechanical Outline
- High speed switching capability
 Logic drive capability (0.8V, 200µA)
- UIS Rated Available with Lot Acceptance Testing
- Ideal for Laser Range finder and Camera Applications
- Ideal for Automotive Collision Avoidance Applications
- Available in 16mm Tape and Reel—6000 units/reel

APPLICATIONS/BENEFITS

 Microsemi Corp DN14 design note

Nanosecond SCR switch for reliable high current pulse generators, modulators and photo-flash quenching.

Several new applications for nanosecond SCR switches include automotive collision avoidance systems, laser drivers, photo-flash quenching circuits, specially developed circuits for the emerging digital imaging range finders and communication markets.



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| ELECTRICAL PARAMETERS@25°C (unless otherwise specified) | | | | | | |
|---|------------------|--|------|------|------|-------|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
| • On characteristics (up to 100 A w/ 100 | ns pulse @ D | uty Cycle = 0.0001% or less) | | | | |
| Forward Blocking Current | I _{DRM} | $V_{DRM} = 100V, R_{GK} = 1k \Omega$ | | | 1.0 | μA |
| On - State Voltage | VT | $I_T = 1A$, $Ig = 10mA$ | | 1.1 | 1.5 | V |
| Gate Trigger Voltage | V_{GT} | $V_{\rm D} = 5V, R_{\rm GS} = 100\Omega$ | | 0.5 | 0.75 | V |
| Gate Trigger Current | I _{GT} | $V_D = 5V, R_{GS} = 10k\Omega$ | | 2 | 20 | μA |
| Reverse Gate Current | I _{GR} | $V_{GR} = 5V$ | | 0.01 | 0.1 | mA |
| Holding Current | $I_{\rm H}$ | $V_D = 5V, R_{GK} = 1k\Omega$ | 0.3 | 1.0 | 2.5 | mA |
| Reverse Current (note 1) | I _{RRM} | V_{RRM} = 30V, R_{GK} = 1k Ω | | 1 | 10 | mA |
| Switching characteristics (Tc = 25 °C) | | | | | | |
| Delay Time | td | Ig = 20 mA, I _T = 1A | | 20 | 30 | ns |
| Rise Time | tr | $V_D = 100V, I_T = 1A, Ig = 10mA$ DC < 1% | | 15 | 25 | ns |
| Circuit Commutated Turn—off Time | tq | $I_T = I_R = 1A, R_{GK} = 1k\Omega$ | | 0.3 | 0.5 | μS |
| Gate Trigger—on Pulse Width | tpg(on) | $Ig = 10mA, I_T = 1A$ | | 20 | 50 | ns |
| Critical Rate of Rise Off –State Voltage | dv/dt | $V_{\rm D}$ = 30V, R _{GK} = 1k Ω | 15 | 30 | | V/µs |

Note 1: Pulse Test intended to guarantee reverse anode voltage capability for pulse commutation.

SPICE MODEL

.subckt SCR anode gate cathode PARAMS:

| * Powermite 3 UPGA301A high-speed thyristor | | | | | |
|---|-----------|------------|----------|--|--|
| +Vdrm=125V | Vrrm=30V | Idrm=1µA | lh=5mA | | |
| +dvdt=7E5V/s | lgt=200µA | Vgt=0.75V | Vtm=1.5V | | |
| +ltm=2A | ton=55ns | toff=500ns | | | |
| .END | | | | | |

ELECTRICALS

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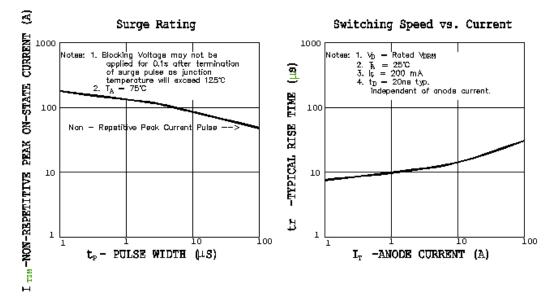


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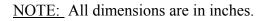
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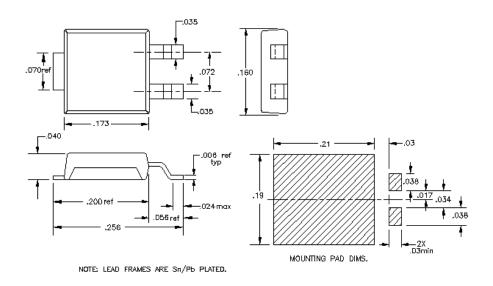
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Case: Molded Epoxy Meets UL94VO at 1/8 inch Weght: 72 milligrams Lead and Mounting Temperature: 260°C max for 10 seconds





PACKAGE DATA

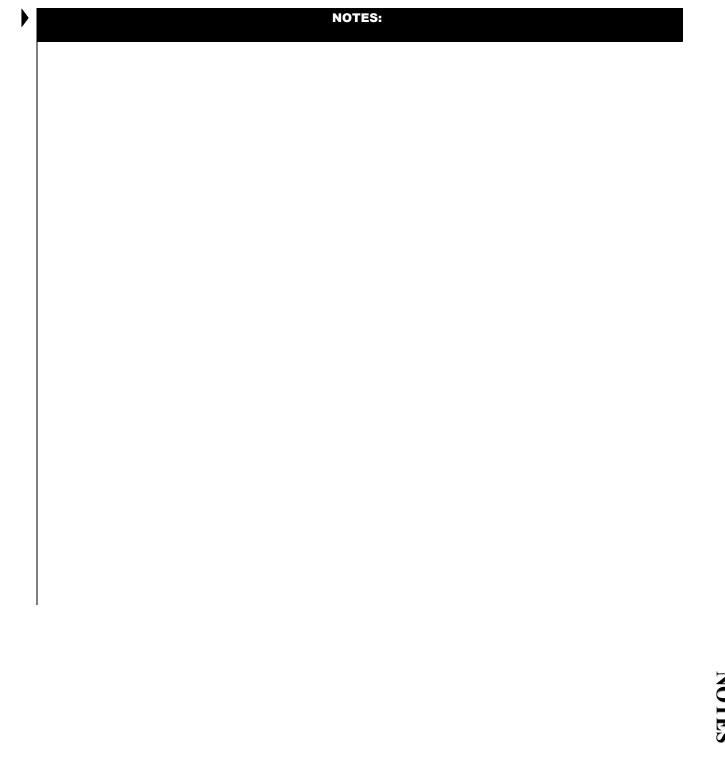


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Mouser Electronics

Authorized Distributor

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